SEMICONDUCTOR®

# **MPS6521**

# **NPN General Purpose Amplifier**

- This device is deisgned for general purpose amplifier applications at collector to 300mA.
- Sourced from process 10.



MPS6521

1. Emitter 2. Base 3. Collector

# Absolute Maximum Ratings Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	25	V
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	4.0	V
Ι <sub>C</sub>	Collector Current - Continuous	100	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

# **Electrical Characteristics** $T_a=25^{\circ}C$ unless otherwise noted

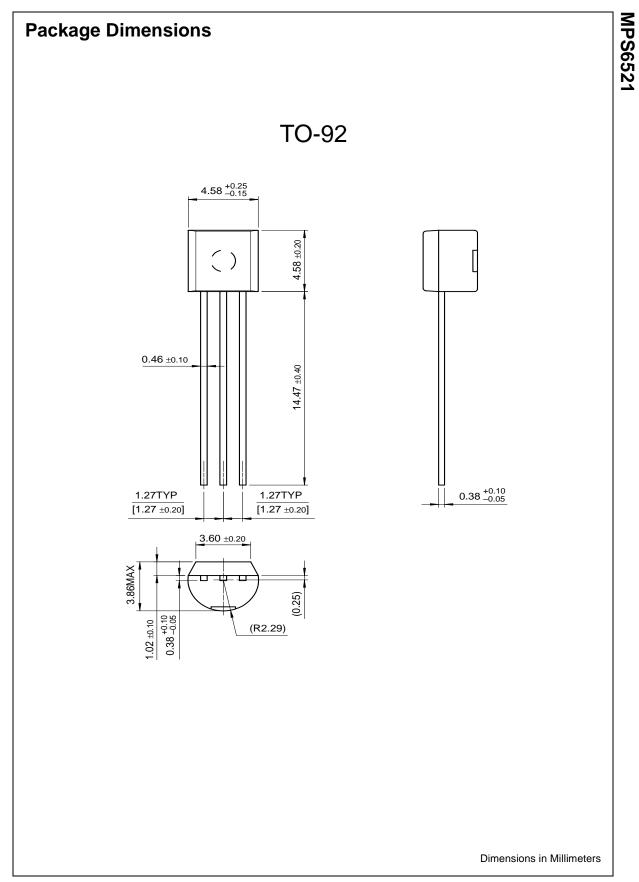
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics				
V <sub>(BR)CEO</sub>	Collector-Emitter Sustaining Voltage *	$I_{\rm C} = 500 \mu {\rm A}, I_{\rm B} = 0$	25		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	4		V
I <sub>CBO</sub>	Emitter Cutoff Current	$V_{CB} = 30V, I_E = 0$		50	nA
On Characte	eristics				
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 10V, I_{C} = 100\mu A$ $V_{CE} = 10V, I_{C} = 2.0mA$	150 300	600	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_{\rm C} = 50 {\rm mA}, I_{\rm B} = 5.0 {\rm mA}$		0.5	V

\* Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%

## Thermal Characteristics $T_a=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Units
PD	Total Device Dissipation	625	mW
	Derate above 25°C	5	mW/°C
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

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